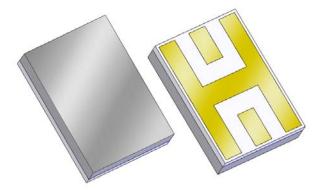
# Applications

- For SSR/IFF Applications
- For high-selectivity applications



# **Product Features**

# **Functional Block Diagram**

- Usable bandwidth 16 MHz
- Low loss
- High selectivity
- Single-ended operation
- Ceramic chip-scale Package (CSP)
- Small Size
- Hermetic **RoHS** compliant, **Pb**-free

# Pin Configuration

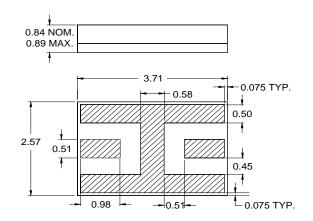
Pin # SE-Balanced	Description
I/O	Input/Output
GND	Ground

# I/O GND

Overall width, length, and thickness are the only critical dimensions. All other dimensions are for reference only.

Dimensions shown are nominal in millimeters All tolerances are  $\pm 0.13$ mm except overall length and width  $\pm 0.25$ mm

#### Body: *Sapphire* Package: *Alumina* Terminations: *Au* plating 0.5 - 2.5μm, over a 2.0 – 6.0 μm *Ni* plating



# **Ordering Information**

Part No.	Description
880374	packaged part
880374 Eval Board	evaluation board

# **Specifications**

# **Electrical Specifications**<sup>(1)</sup>

Specified Temperature Range: <sup>(2)</sup> -40 to +85 °C

Parameter <sup>(3)</sup>	Conditions	Min	Typical <sup>(4)</sup>	Max	Units
Center Frequency		-	1090	-	MHz
Maximum Insertion Loss	@ 1090 MHz	-	3.0	4.0	dB
3dB Bandwidth	Reference loss at 1090 MHz	16	22	-	MHz
40dB Lower Frequency Edge		1067.5	1073	-	MHz
40dB Upper Frequency Edge		-	1107	1112.5	MHz
VSWR	@ 1090 MHz	-	1.7	2.0	-
Source Impedance (single-ended) <sup>(5)</sup>		-	50	-	Ω
Load Impedance (single-ended) <sup>(5)</sup>		-	50	-	Ω

Notes:

1. All specifications are based on the TriQuint schematic for the main reference design shown on page 3

2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature

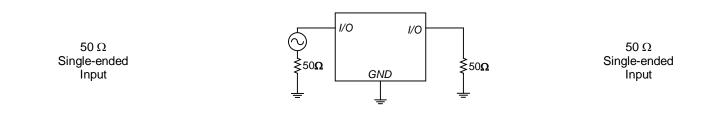
3. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances

4. Typical values are based on average measurements at room temperature

5. This is the optimum impedance in order to achieve the performance shown

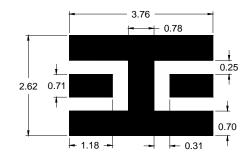
# **Reference Design**

# Schematic



**PC Board** 

# **Mounting Configuration**



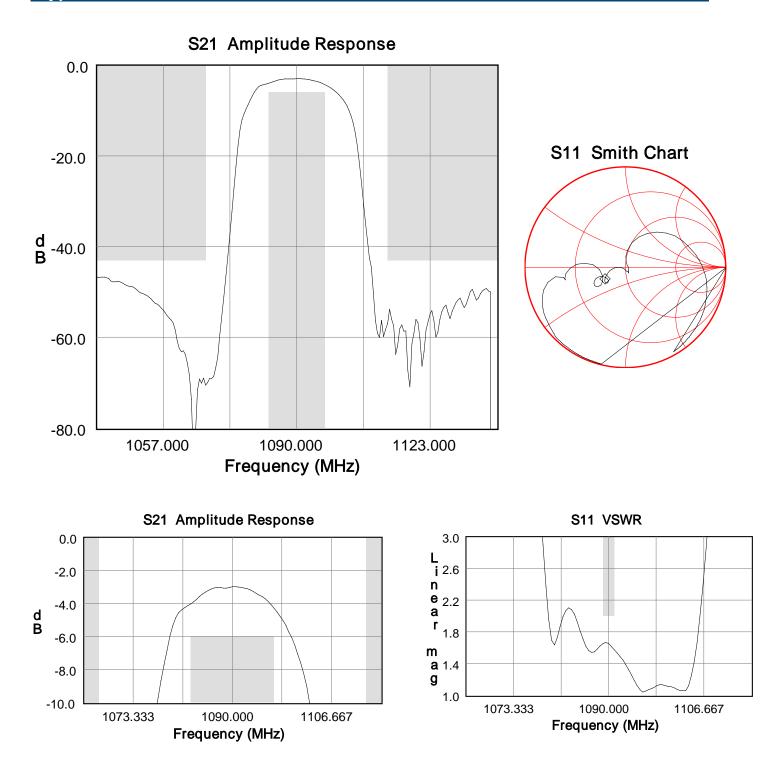
Refer to **PCB Layout** for more information.

Notes:

1. All dimensions are in millimeters.

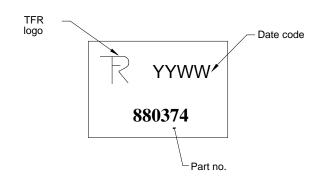
2. This footprint represents a recommendation only.

# Typical Performance (at room temperature)



### **Mechanical Information**

### Marking



The date code consists of: YY = last digit of year, WW = 2 digit week

### **Tape and Reel Information**

Tape and Reel available upon request EIA-481

Tinning available per J-STD-001

### **Absolute Maximum Ratings**

Parameter	Rating
Operating Temperature	-40 to +85 °C
Storage Temperature	-55 to +100 °C
Maximum Input Power	+23 dBm

Operation of this device outside the parameter ranges given above may cause permanent damage.

### **Product Compliance Information**

### **ESD** Information



# Caution! ESD-Sensitive Device

Value:	Passes ≥ 8000 V min.
Test:	Human Body Model (HBM)
Standard:	JEDEC Standard JESD22-A114
Value:	Passes ≥ 800 V min.
Test:	Machine Model (MM)
Standard:	JEDEC Standard JESD22-A115

Refer to **ESD Sensitivity** for data

### **Solderability**

Compatible with the latest version of J-STD-020, lead free solder, 260°C

Refer to Soldering Profile for recommended guidelines.

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A ( $C_{15}H_{12}Br_40_2$ ) Free
- PFOS Free
- SVHC Free

#### **Contact Information**

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about TriQuint:

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